

3.3V PCI Express[®] 3.0 4 Channel 2x2 Exchange Switch

Features

- → 4 Differential Channel 2x2 Exchange Switch
- → PCI Express[®] 3.0 performance, 8.0 Gbps
- → Bi-directional operation
- → Low Bit-to-Bit Skew: 10ps (between ± signals)
- → Low Crosstalk: -29dB @ 2.5GHz (5Gbps) -20dB @ 4.0GHz (8Gbps)
- → Low Insertion Loss: -1.1dB @ 2.5GHz (5Gbps)
 - -1.45dB @ 4.0GHz (8Gbps)
- → V_{DD} Operating Range: 3.3V ±10%
- → Industrial Temperature Range: -40°C to 85°C
- → ESD Tolerance: 2kV HBM
- → Packaging (Pb-free & Green):
 - □ 30-contact, TQFN (ZL30), 2.5 x 4.5mm.

Description

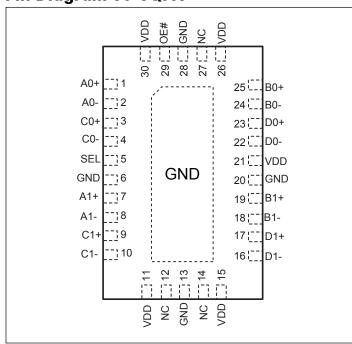
The PI3PCIE3242A is a differential exchange switch featuring pass-through pinout. It supports one full PCI Express® lane 2x2 Exchange Switch operating at 8.0Gbps PCIe® 3.0 performance.

With the select control input low, Port A connects to Port B, and Port C connects to port D for an 8-channel differential pass-though. When the select control input is high Port A connects to Port D, and Port B connects to Port C.

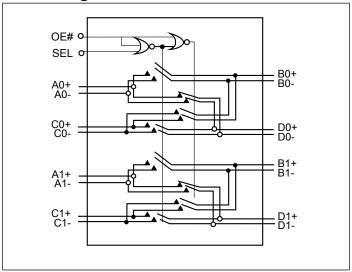
Truth Table

Function	SEL	OE#
Ax = Bx $Cx = Dx$	0	0
Ax = Dx $Cx = Bx$	1	0
Ax, Bx , Cx , $Dx = Hi-Z$ (disconnect)	x	1

Pin Diagram 30-TQFN



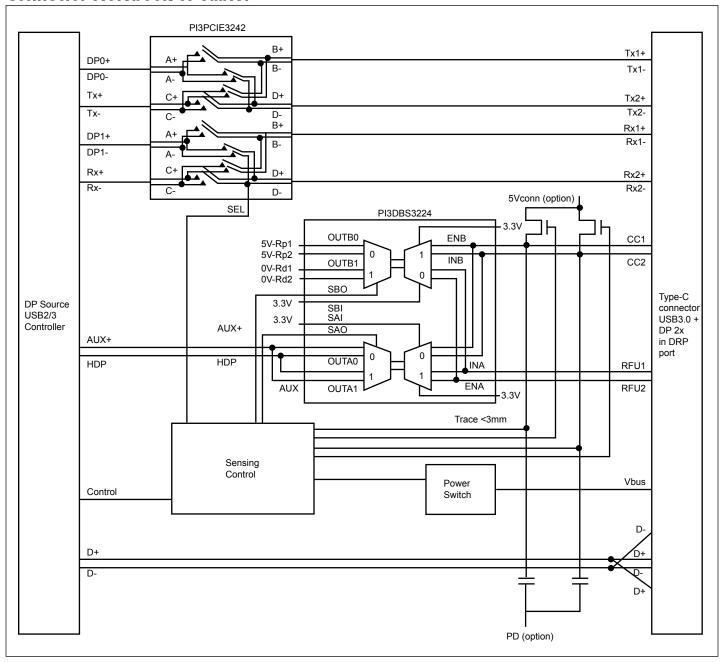
Block Diagram







Application Diagram in Switching 2 Lanes of DP1.2 & USB 3.0 Signals Over Type C Connector Notebook or Tablet







Pin Description (30-TQFN)

Pin #	Pin Name	I/O	Description
1	A0+	I/O	Signal I/O, Channel 0, Port A
2	A0-		
7	A1+	I/O	Signal I/O, Channel 1, Port A
8	A1-		
25	B0+	I/O	Signal I/O, Channel 0, Port B
24	В0-		
19	B1+	I/O	Signal I/O, Channel 1, Port B
18	B1-		
3	C0+	I/O	Signal I/O, Channel 0, Port C
4	C0-		
9	C1+	I/O	Signal I/O, Channel 1, Port C
10	C1-		
23	D0+	I/O	Signal I/O, Channel 0, Port D
22	D0-		
17	D1+	I/O	Signal I/O, Channel 1, Port D
16	D1-		
29	OE#	I	Output Enable, active low. When OE# = 0 the device I/O is enabled. When OE#=1, all I/O are high impedance
5	SEL	I	Operation mode Select (when SEL=0: A→B, C→D, when SEL=1: A→D, C→B)
11, 15, 21, 26, 30	V_{DD}	Pwr	3.3V ±10% Positive Supply Voltage
6, 13, 20, 28, Center Pad	GND	Pwr	Power ground
12, 14, 27	NC		No Connect





Maximum Ratings

(Above which useful life may be impaired. For user guidelines, not tested.)

Storage Temperature	65°C to +150°C
Supply Voltage to Ground Potential	0.5V to +3.7V
DC Input Voltage	0.5V to V _{DD}
DC Output Current	120mA
Power Dissipation	0.5W
Junction Temperature	125°C

Note: Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Electrical Characteristics Recommended Operating Conditions

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
V _{DD}	3.3V Power Supply		3.0	3.3	3.6	V
I_{DD}	Total current from V _{DD} 3.3V supply	SEL and OE# at OV or V _{DD}			200	μΑ
$T_{\mathbf{A}}$	Operating temperature range		-40		85	°C

DC Electrical Characteristics for Switching over Operating Range

Parameters	Description	Test Conditions ⁽¹⁾	Min.	Typ.(1)	Max.	Units
V_{IH}	Input HIGH Voltage	Guaranteed HIGH level	0.65 x			
· 1n			V_{DD}			
$V_{\rm IL}$	Input LOW Voltage	Guaranteed LOW level	-0.5		0.35 x	V
VIL	L input LOW voltage Guaranteed LOW		-0.5		V_{DD}	
V_{IK}	Clamp Diode Voltage	$V_{DD} = Max., I_{IN} = -18mA$		-0.7	-1.2	
I_{IH}	Input HIGH Current, SEL	$V_{DD} = Max., V_{IN} = V_{DD}$	-10		+10	
I_{IL}	Input LOW Current, SEL	$V_{DD} = Max., V_{IN} = GND$	-10		+10	μΑ
IIH	Input HIGH Current, A_X , B_X , C_{X_1} , D_X $V_{DD} = Max.$, $V_{IN} = 1.8V$ -10		+10	4		
IIL	Input LOW Current, A _X , B _X , C _X ,D _X	$V_{DD} = Max., V_{IN} = 0V$	-10		+10	μА

Note:

Switching Characteristics

Parameters	Description	Test Conditions	Min.	Тур.	Max.	Units
t _{PZH} , t _{PZL}	Line Enable Time - SEL to A_N , B_N , C_N , D_N		0.5		45	
$t_{\mathrm{PHZ}}, t_{\mathrm{PLZ}}$	Line Disable Time - SEL to A_N , B_N , C_N , D_N		0.5		25	ns
t _{b-b}	Bit-to-bit skew within the same differential pair				10	
t _{ch-ch}	Channel-to-channel skew				20	ps

^{1.} Typical values are at VDD = 3.3V, TA = 25°C ambient and maximum loading.





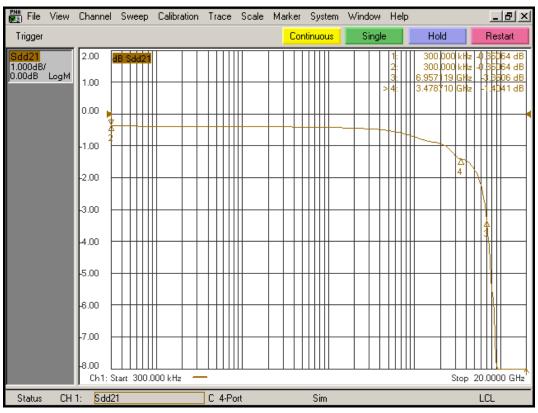
Dynamic Electrical Characteristics

Parameter	Description	Test Conditions	Min.	Typ.(1)	Max.	Units
		f=1.2GHz		-0.8	-1.0	
		f=2.5GHz		-1.0	-1.2	
DDIL	Differential Insertion Loss	f=4.0GHz		-1.3	-1.9	dB
	$(V_{IN} = -10dBm, DC = 0V)$	f=5.0GHz		-1.8	-2.6	
		f=7.5GHz		-4.5	-5.6	
$\mathrm{DDIL}_{\mathrm{OFF}}$	Differential Off Isolation	f= 4.0GHz		-19		dB
		f= 0 to 2.8GHz		-26		
DDRL	Differential Return Loss	f= 2.8 to 5.0GHz		-14		dB
		f= 5.0 to 8.0GHz		-7.5		
	Near End Crosstalk	f= 0 to 2.8GHz		-26		
DDNEXT		f= 2.8 to 5.0GHz		-20		dB
		f= 5.0 to 8.0GHz		-16		
V _{I F}		Insertion loss 1.5dB, V _{IN} =0.623Vpp, DC=0V		4.0		
	Max Signal Frequency Range	Insertion loss 1.5dB, V _{IN} =0.623Vpp, DC=0.9V		4.0		CII-
		Insertion loss 3dB, V _{IN} =0.623Vpp, DC=0V		8.0		GHz
		Insertion loss 3dB, V _{IN} =0.623Vpp, DC=0.9V		8.0		
BW	-3dB Bandwidth			6.5		GHz

Notes:

1. Guaranteed by design. Typical values are at $\rm V_{DD}$ = 3.3V , $\rm T_A$ = 25°C ambient and maximum loading.

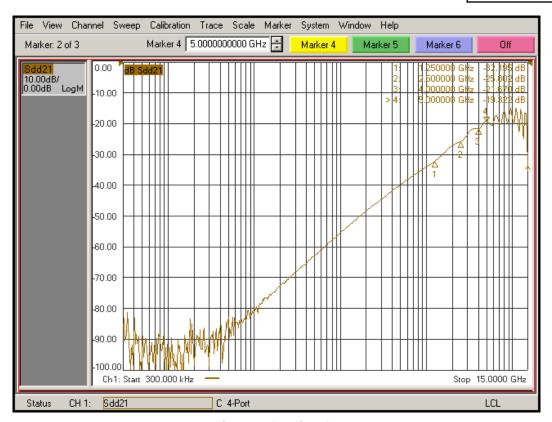




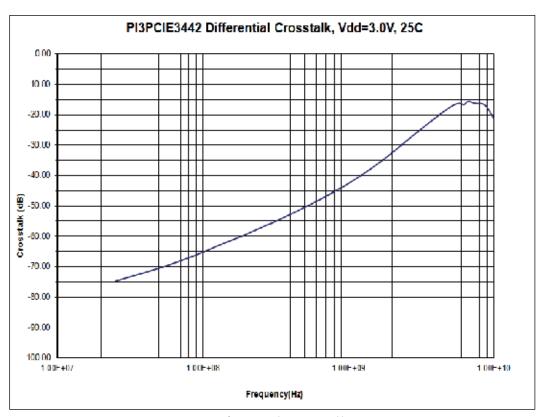
Differential Insertion Loss





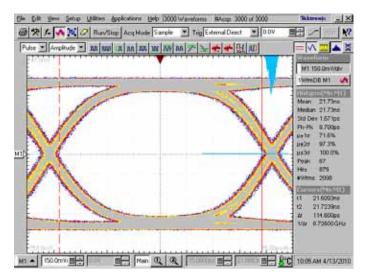


Differential Off Isolation

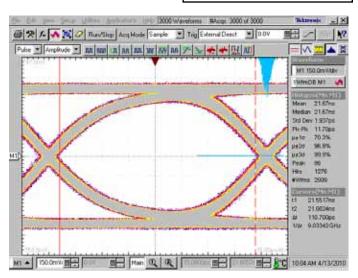




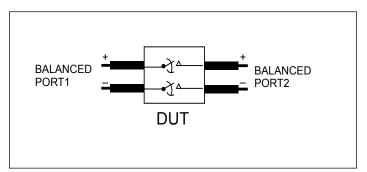




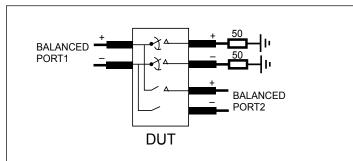
8.0 Gbps RX signal eye without PI3PCIE3242A



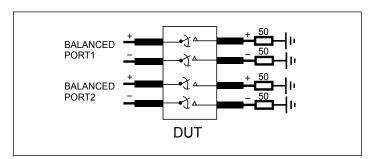
8.0 Gbps RX signal eye with PI3PCIE3242A



Differential Insertion Loss and Return Test Circuit



Differential Off Isolation Test Circuit

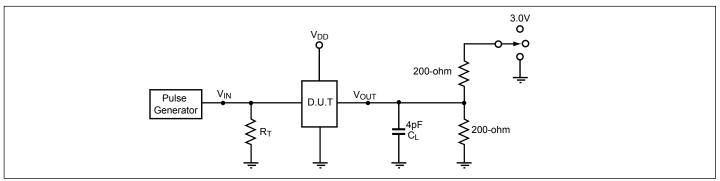


Differential Near End Xtalk Test Circuit





Test Circuit for Electrical Characteristics⁽¹⁻⁵⁾



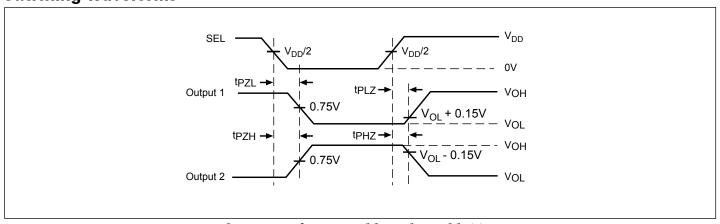
Notes:

- 1. C_L = Load capacitance: includes jig and probe capacitance.
- 2. R_T = Termination resistance: should be equal to Z_{OUT} of the Pulse Generator
- 3. Output 1 is for an output with internal conditions such that the output is low except when disabled by the output control. output 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- 4. All input impulses are supplied by generators having the following characteristics: PRR \leq MHz, $Z_O = 50\Omega$, $t_R \leq$ 2.5ns, $t_F \leq$ 2.5ns.
- 5. The outputs are measured one at a time with one transition per measurement.

Switch Positions

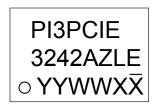
Test	Switch
$t_{\rm PLZ}, t_{\rm PZL}$	3.0V
$t_{\mathrm{PHZ}}, t_{\mathrm{PZH}}$	GND
Prop Delay	Open

Switching Waveforms



Voltage Waveforms Enable and Disable Times

Part Marking Information



YY: Year

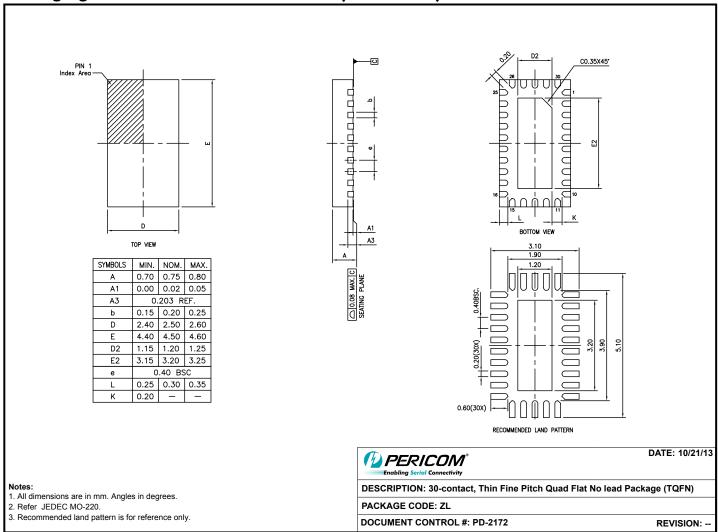
WW : Workweek 1st X: Assembly Code 2nd X: Fab Code

www.diodes.com





Packaging Mechanical: 30-Contact TQFN (2.5x4.5mm)



14-0006

For latest package info.

 $please\ check: http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/packaging-mechanical-and-thermal-characteristics/packaging-mecha$

Ordering Information

Ordering Code	Package Code	Package Description
PI3PCIE3242AZLEX	ZL	30-contact, Thin Fine Pitch Quad Flat No-Lead (TQFN)

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Notes:

- Thermal characteristics can be found on the company web site at www.diodes.com/design/support/packaging/
- E = Pb-free and Green
- X suffix = Tape/Reel





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